

High IP3 Frequency Mixer

Level 10 (LO Power +10 dBm) 818 to 853 MHz

HJK-9LH+ HJK-9LH



Maximum Ratings

Operating Temperature -40°C to 85°C

Storage Temperature -55°C to 100°C

LO & RF Power +16 dBm

Permanent damage may occur if any of these limits are exceeded.

Pin Connections

LO	2
RF	1
IF	3
GROUND	4,5,6

Features

- high IP3, 27 dBm typ.
- compression, 3 dB higher than LO

Applications

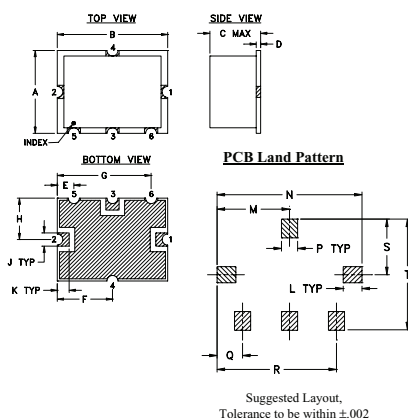
- base stations
- communication systems
- PCS

CASE STYLE: TTT167
PRICE: \$12.95 ea. QTY (1-9)

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

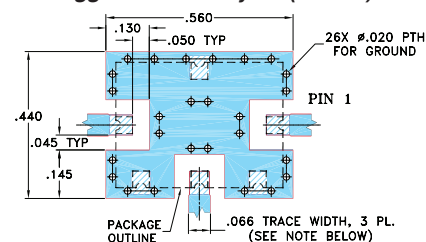
Outline Drawing



Outline Dimensions (inch mm)

A	B	C	D	E	F	G	H	J	K
.38	.50	.23	.020	.075	.250	.425	.187	.050	.050
9.65	12.70	5.84	0.51	1.91	6.35	10.80	4.75	1.27	1.27
L	M	N	P	Q	R	S	T		wt.
.070	.270	.540	.060	.095	.445	.208	.415		grams
1.78	6.86	13.72	1.52	2.41	11.30	5.28	10.54		0.8

Demo Board MCL P/N: TB-12 Suggested PCB Layout (PL-079)



NOTE:

1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .030" ± .002". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. THE USE OF SOLDER MASK OVER THE GROUND AREA UNDER THE UNIT AS SHOWN IS RECOMMENDED TO PREVENT POTENTIAL SHORTING. IF USER CHOOSES TO EXPOSE METAL UNDER THE ENTIRE UNIT GROUND PAD FOR IMPROVED GROUNDING, IT IS RECOMMENDED A SOLDER MASK DAM BE APPLIED AROUND EACH GROUND PAD TO ENSURE FILLET AND CONNECTION AT GROUND PADS.
3. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

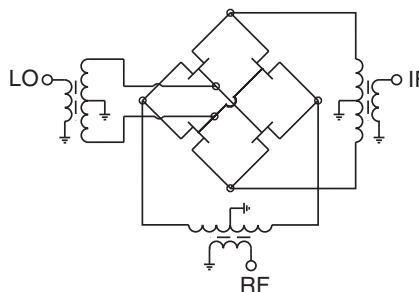
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IF/RF MICROWAVE COMPONENTS

For detailed performance specs & shopping online see web site

Electrical Schematic

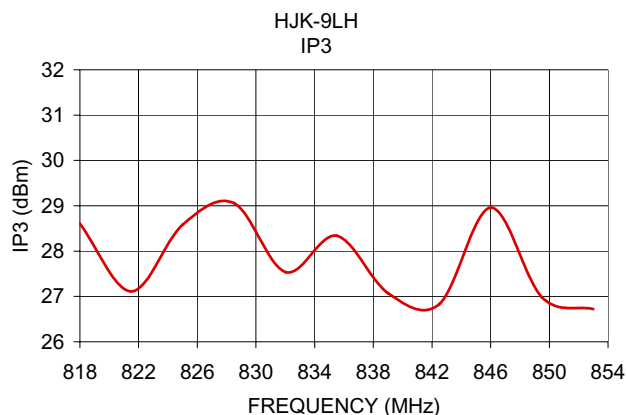
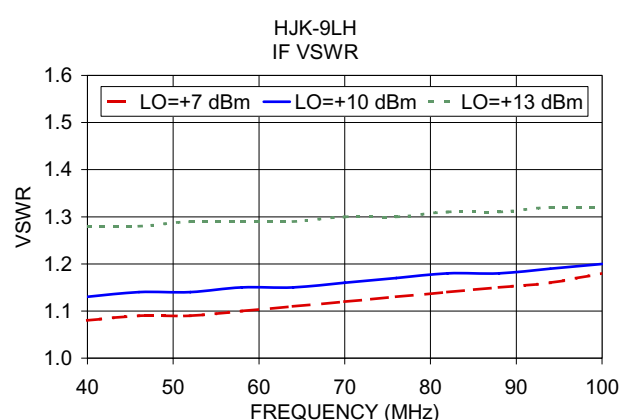
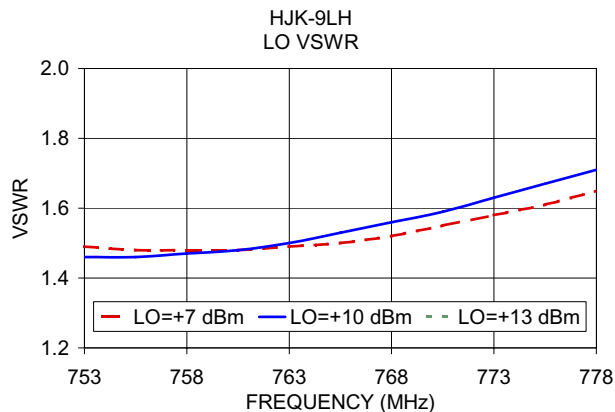
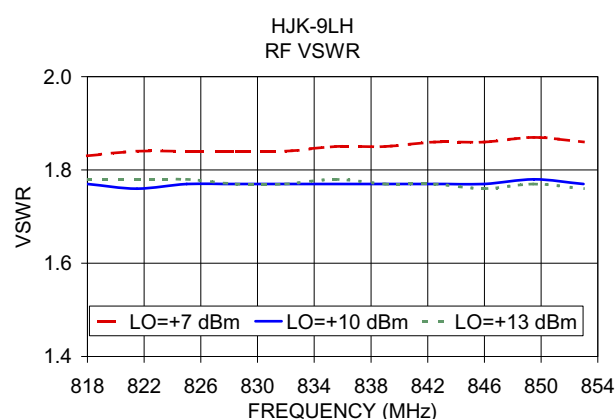
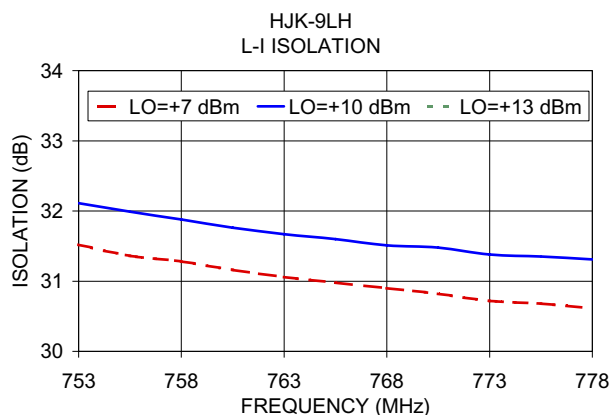
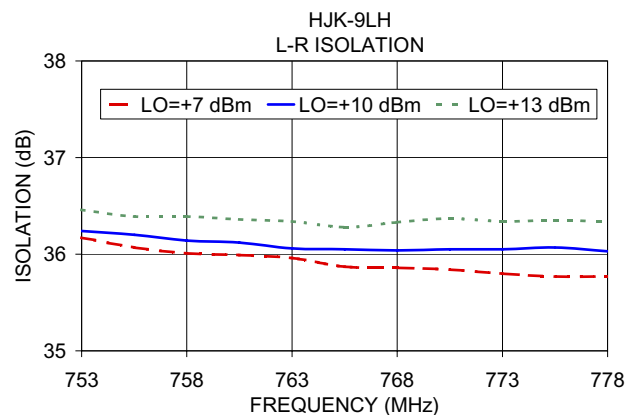
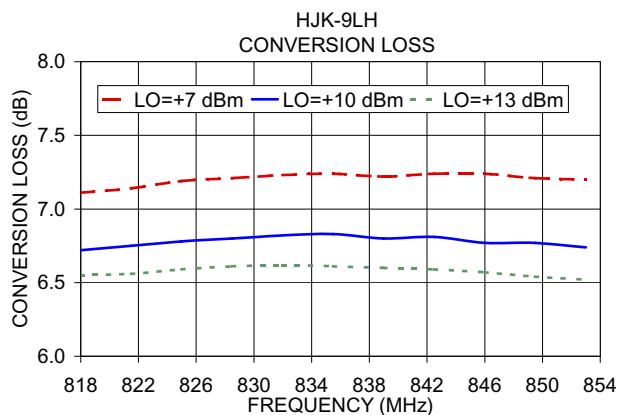


Notes: 1. Performance and quality attributes and conditions not expressly stated in this specification sheet are intended to be excluded and do not form a part of this specification sheet. 2. Electrical specifications and performance data contained herein are based on Mini-Circuit's applicable established test performance criteria and measurement instructions. 3. The parts covered by this specification sheet are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp.

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Performance Charts

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